

To: Dear customer

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Subject : Notification of change to the new packing box for MITSUBISHI Silicon RF Power modules.

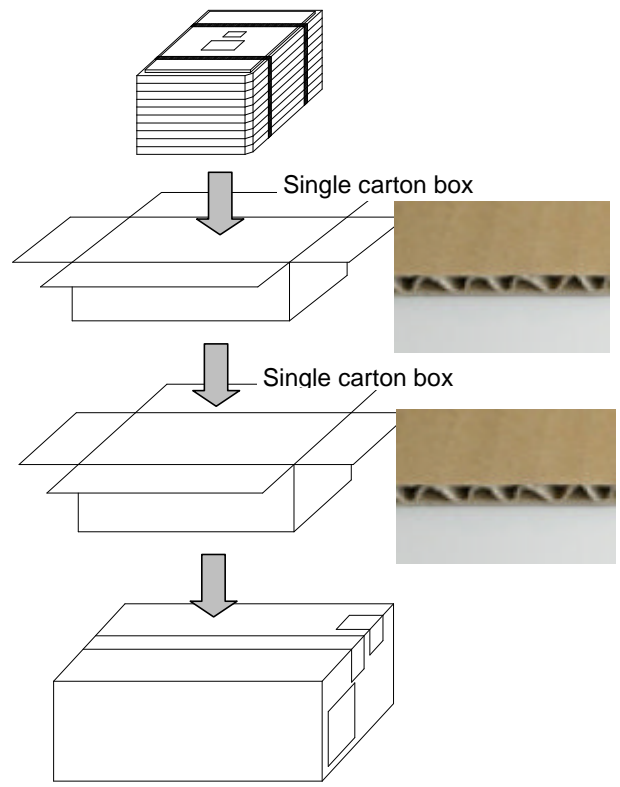
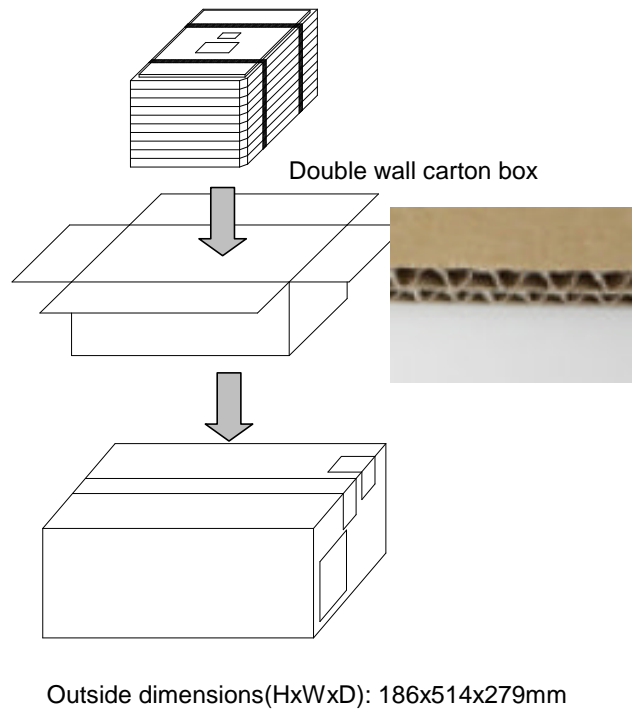
We will change the packing box to "double wall carton box" from "double box packaging".

We confirmed that there was no problem with transportation test and Vibration test.

As a result,new packing is the same as current packing strength.

We appreciate your kindly understanding and cooperation in advance.

Products subject, Reason of change, Change schedule

Subject	Product name	MOS FET RF Power devices.	
	Type number	RA*** series modules.	
Reason of change	Reason of change	To reduce waste disposal. The protection of the environment.	
	Changed contents	Change of the packing box to double wall carton box form double box packaging.	
	Current packing box		New packing box
	Packing box : Double box packaging.   Single carton box Single carton box  Outside dimensions(HxWxD): 195x521x291 mm		Packing box : Packing with double wall carton box.   Double wall carton box  Outside dimensions(HxWxD): 186x514x279mm
Result of transportation test and Vibration test	Test condition (1)Transportation test(JISZ0202) : Dropping Height=0.8m,1set=Dropping 10 times (six sides) (2)Vibration test: ASTM-D4169-09 Standard Practice for Performance Testing of Shipping Containers and Systems. Test result:No problem.There was not the difference for Electric characteristics and appearance of products.		
Change schedule	We are going to change packing method from shipping in Jun 2013.		